	U.S. DEPARTMENT OF COMMERCE	
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1. Name of conveying party:	Name and address of receiving party:	
Boxer Cross Inc.	No. 10 April 1884 - 1 April 1984	
	Name: Applied Materials, Inc. Street Address: 2881 Scott Blvd.	
- 100 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 -	Street Address: 2881 Scott Blvd. City: Santa Clara, CA 95050	
Additional name(s) of conveying party(les) attached?	Country: USA	
Yes 🔀 No		
3. Nature of Conveyance:	Name and address of receiving party(ies):	
Assignment Merger	Name:	
Security Agreement Change of Name	Street Address:	
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Other	Country:	
Execution Date: <u>January 5, 2005</u>	Additional name(s) & address(es) attached?	
	☐ Yes ⊠ No	
4. Application number(s) or patent number(s):	•	
If this document is being filed together with a new application, the	execution date of the application is:	
A. Patent Application No.(s) – 10/722,724; 10/269,619; 10/090,316; 10/223,952; 10/884,673; 09/788,273; 10/090,262; 09/974,571; 10/090,287; 10/253,119; 10/977,380; 10/976,587; and 10/984,463	B. Patent No.(s)	
Additional numbe	rs attached? Yes No	
Name and address of party to whom correspondence concerning document should be mailed:	Total number of applications and patents involved: 13	
Name: Omkar K. Suryadevara		
Internal Address: Silicon Valley Patent Group LLP		
Street Address: 2350 Mission College Boulevard, Suite 360		
City Santa Clara State <u>CA</u> Zip <u>95054</u>	7. Total fee (37 CFR 3.41): \$520.00 Enclosed	
	Charge Deposit Account 50-2263 for any additional fees required for this conveyance and credit deposit account	
	50-2263 any amounts overpaid	
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8. Statement and signature.		
To the best of my knowledge and belief, the foregoing information document.	is true and correct and any attached copy is a true copy of the original	
Omkar K. Suryadevara 36,320 Name of Person Signing	March 30, 2005 Date Date number of pages including cover sheet, attachments, and documents: 3	

PATENT REEL: 015976 FRAME: 0325

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, Boxer Cross Inc., a Delaware corporation, having acquired by prior assignments, the entire right, title, and interest throughout the world in inventions for which United States Patent Applications listed below were filed, as well as any patent applications and patents of every country for said invention, including divisionals, reissues, continuations and extensions or foreign counterparts thereto, and all rights of priority resulting from the filing of said applications:

US		US Patent	Title
Application	1	Number	
No.	Filing Date		
			Apparatus And Method For Measuring A Property
6/10/1998	09/095,805	6,054,868	Of A Layer In a Multilayered Structure
			Apparatus And Method For Measuring A Property
11/25/2003	10/722,724		Of A Layer In a Multilayered Structure
			Apparatus and Method for Evaluating a Wafer of
6/10/1998	09/095,804	6,049,220	Semiconductor Material
	•		Apparatus and Method for Evaluating a Wafer of
4/6/2000	09/544,280	6,489,801	Semiconductor Material
			Apparatus and Method for Evaluating a Wafer of
10/11/2002	10/269,619		Semiconductor Material
i . '			Apparatus and Method For Measuring A Property Of
3/1/2002	10/090,316	ļ. <u>.</u>	A Layer In A Multilayered Structure
			Apparatus And Method For Determining The Active
3/22/1999	09/274,821	6,323,951	Dopant Profile In A Semiconductor Wafer
			Apparatus And Method For Determining The Active
8/21/2001	09/935,128	6,426,644	Dopant Profile In A Semiconductor Wafer
	•		Apparatus And Method For Determining The Active
11/26/2001	09/994,441	6,483,594	Dopant Profile In A Semiconductor Wafer
l			Apparatus And Method For Determining The Active
8/19/2002	10/223,952		Dopant Profile In A Semiconductor Wafer
			Apparatus And Method For Determining The Active
7/2/2004	10/884,673		Dopant Profile In A Semiconductor Wafer
li			Evaluating a Geometric or Material Property of a
3/8/2000	09/521,232	6,812,047	Multilayered Structure
			Evaluating Sidewall Coverage In A Semiconductor
2/16/2001	09/788,273	_	Wafer
		1	Use Of A Coefficient Of A Power Curve To Evaluate
3/5/2001	09/799,481	6,812,717	A Semiconductor Wafer
3/1/2002	10/090,262		Evaluating A Multi-layered Structure For Voids
		1	Calibration As Well As Measurement On The Same
10/9/2001	09/974,571	<u> </u> .	Workpiece During Fabrication
4440000			Identifying Defects In A Conductive Structure Of A
4/1/2002	10/090,287	!	Wafer Based on Heat Transfer Therethrough
0/00/0000	40/050 446	1	Measurement Of Lateral Diffusion Of Diffused
9/23/2002	10/253,119		Layers
10/29/2004	10/977,380	 	Evaluating a Property of a Multilayered Structure
10/00/0004	401070 507		Use Of A Coefficient Of A Power Curve To Evaluate
10/29/2004	10/976,587		A Semiconductor Wafer
[11/8/∠UU 4]	10/984,463		Evaluating A Multilayered Structure For Voids

PATENT REEL: 015976 FRAME: 0326 hereby sells, assigns and transfers to Applied Materials Inc, a Delawarc corporation, having a place at 2881 Scott Blvd, Santa Clara, CA 95050, its successors and assigns, the entire right, title and interest throughout the world in the above-identified patent applications as well as any patent applications and patents of every country for said inventions.

Executed this __5th day of ___January, 2005

For: Boxer Cross Inc.

President

State of County of County of

24 5, 200 before me, _ personally appeared Patrick Lamey personally known to me or proved to me on the basis of satisfactory evidence to be the person whose name is subscribed to the within instrument and acknowledged to me that he executed the same in his authorized capacity, and that by his signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

My Comm. Explice Oct 15, 2007

PATENT REEL: 015976 FRAME: 0327

RECORDED: 03/30/2005